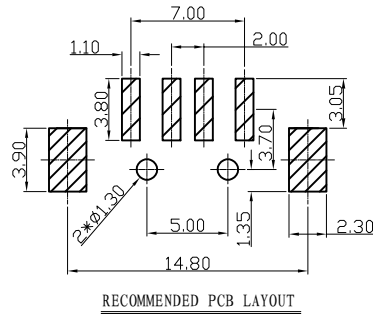
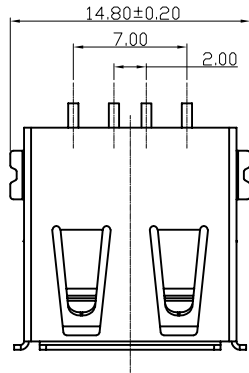


RoHS Compliant

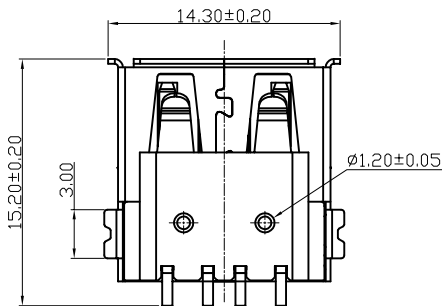
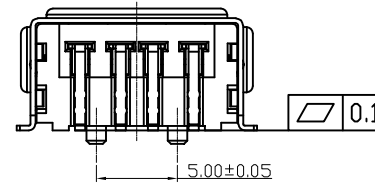
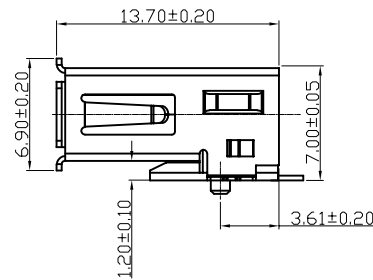
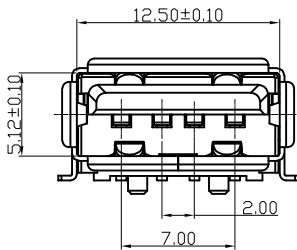
REVISIONS			
REV.	DESCRIPTION	DATE	DESIGN



NOTES:

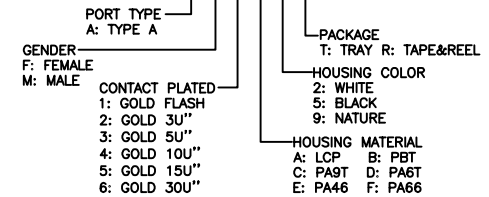
- MATERIAL SPECIFICATION
 - INSULATION MATERIAL THERMOPLASTIC.
 - SHELL: COPPER ALLOY, T: 0.30mm
PLATING: NICKEL
 - TERMINAL: COPPER ALLOY, T: 0.25mm
PLATING: GOLD/TIN PLATED.
- ELECTRICAL CHARACTERISTIC:
 - INSULATION RESISTANCE: 1000MΩ MIN.
 - CONTACT RESISTANCE: 30mΩ MAX.
 - WITHSTANDING VOLTAGE: 500V AC.
- MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE: 3.57Kgf MAX.
 - EXTRACTION FORCE: 1.02Kgf MIN.
- ENVIRONMENTAL:

OPERATING TEMPERATURE: -55° C ~ +85° C



PART NO. INFORMATION

U02-A F X X 5 T - 012



Bestcreate Technology Limited

TOLERANCES UNLESS OTHERWISE SPECIFIED:			
X.	± 0.50	X.*	± 3'
.X	± 0.30	.X*	± 2'
.XX	± 0.20	.XX*	± 1'

Website: www.bsc-elec.com
Email: bestcreate@bsc-elec.com

DESIGN:	DATE:
I. L	2017. 3. 1
CHECKED:	DATE:
C. W	2017. 3. 1
APPROVED:	DATE:
C. W	2017. 3. 1

TITLE: USB2.0 A/F SMT 90° WITH FLANGE		
MATERIAL:	PART NO: U02-AFXX5T-012	SIZE: A4
FINISH:	DWG NO: U02-AFXX5T-012	

REV: A	UNIT mm	SCALE 1=1	QUALITY SYMBOLS	
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